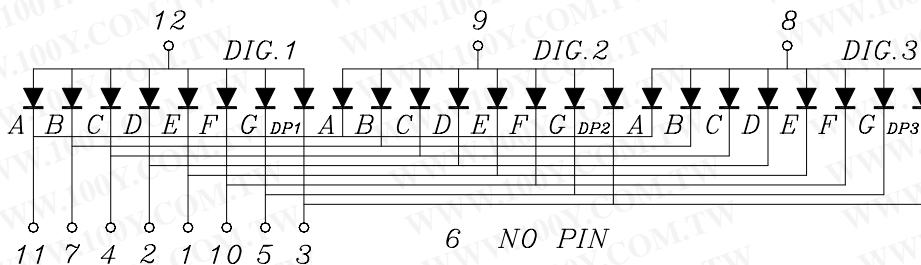
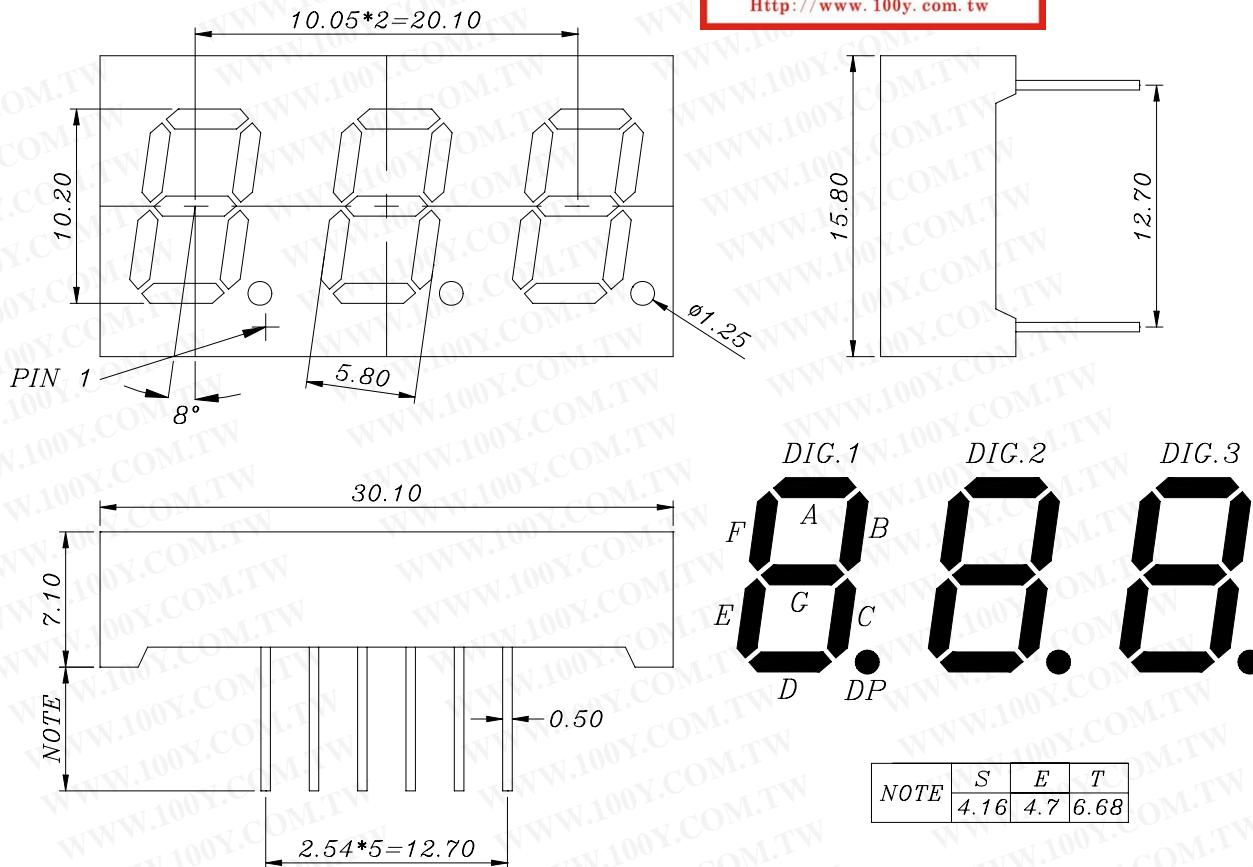


Package Dimensions



- 1. CATHODE E
- 2. CATHODE D
- 3. CATHODE DP1, DP2, DP3
- 4. CATHODE C
- 5. CATHODE G
- 6. NO PIN
- 7. CATHODE B
- 8. COMMON ANODE DIG. 3
- 9. COMMON ANODE DIG. 2
- 10. CATHODE F
- 11. CATHODE A
- 12. COMMON ANODE DIG. 1

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.30\text{mm}(.010\text{'})$ unless otherwise noted.
3. Protruded resin under flange is 1.0mm(.04") max.
4. Lead spacing is measured where the leads emerge from the package.
5. Specifications are subject to change without notice.

Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Average Luminous Intensity	IV	10	13		mcd	IF = 20mA
Peak Emission Wavelength	λP		660		nm	IF = 20mA
Dominant Wavelength	λd	635	639	650	nm	IF = 20mA
Spectral Line Half-Width	$\Delta \lambda$		20		nm	IF = 20mA
Forward Voltage, any Segment or D..P.	VF		1.9	2.4	V	IF = 20mA
Reverse Current, any Segment or D..P	IR			100	μA	VR = 5V
Luminous Intensity Matching Ratio	Iv-m			2:1		IF = 20mA

Absolute Maximum Ratings at TA=25°C

Parameter	Maximum Rating	Unit
Power Dissipation	45	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	90	mA
Continuous Forward Current	20	mA
Reverse Voltage	5	V
Operating Temperature Range	-20°C to +80°C	
Storage Temperature Range	-55°C to +100°C	
Lead Soldering Temperature [1.6mm(.063") From Body]	260°C for 5 Seconds	

TYPICAL ELECTRON-OPTICAL CHARACTERISTIC CURVES
25°C Free Air Temperature Unless Otherwise Specified